

Thermal Gap Pad EU-TP120A



SPECIFIC PRODUCT CHARACTERISTICS:

Features&Benefits	Configurations	Typical application
 Thermal Conductivity: 1.2 W/mK High conformability Electrically insulating Naturally tacky 	 Sheet 200x400mm Die-cut parts Kiss cut parts on sheet 	 Between electronic components such as Semiconductor, IC, CPU.MOS and heatsink. Led Lighting, LCD TV, Telecom device, wireless Hub,NB, PC, power supply etc Cooling Module, Thermal module, in all applications where a metal housing is used as heatsink.

CUSTOMIZATIONS:

Die Cutting	Water Jet Cut	Plotter Cut

 $Euro\ Technologies\ Srl-info@euro-technologies.eu-www.euro-technologies.eu$



PRODUCT PROPERIES:

Properties	Units	Metric Value	Test Method
Composition	_	Ceramic filled Silicone	-
Colour	_	Pink	Visual
Thickness Range	mm	1,0≈12,0	-
Hardness	Shore C	10	ASTM D2240
Density	g/cc	2,3	ASTM D792
Tensile Strenght	kN/m	1	ASTM D412
Elongation	%	70%	ASTM D412
Continuous Use Temp	°C	-40 to 150	EN344
Breakdown Voltage	kV/mm	≥ 6,5	ASTM D149
Volume Impedance	Ohm-cm	3,5*10 ¹²	ASTM D257
Dielectric Constant	1MHz	3,87	ASTM D150
Flammability Rating	-	V-0	UL94
Thermal Conductivity	W/m.K	1,2	ASTM E1461
UL,RoHS, REACH	-	Compliance	

Our customer are reminded that they bear the responsibility for testing Euro Technologies, Srl materials for their proposed use. Due to various application possibilities and conditions which are beyond our control, customers should carry out their own tests to determine the suitability for individual applications.

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